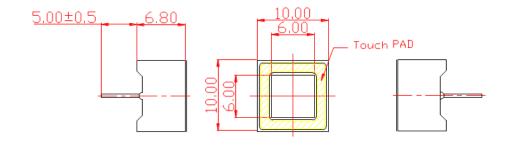
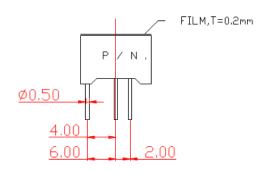


## **SPECIFICATIONS**

# CTD3939GT2WB

### **OUTLINES DIMENSIONS**





#### Notes:

- 1. All Dimensions are in millimeters (inches).
- 2. Tolerance is ± 0.25mm (0.01") unless otherwise noted.
- 3. Specifications are subject to change without notice.

Part Number	Chip Material	Color of Emission	Lens Type	Description	
CTD3939GT2WB	InGaN	Green	White	Touch Display	



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## **ABSOLUTE MAXIMUM RATINGS**

(TA=25°C)

Parameter	Symbol	Max Rating	Unit
Power Dissipation	Pb	120	mW
Continuous Forward Current (Per Dice)	lF	30	mA
Peak Current (Per Dice)	lFP	100	mA
Reverse Voltage (Per Dice)	VR	5	V
Operating Temperature Range	Topr	-25~+85	°C
Storage Temperature Range	Тѕтс	-25~+85	°C
Hand Soldering Condition: 360 °C/ 3sec			

## **OPTICAL-ELECTRICAL CHARACTERISTICS**

(TA=25°C)

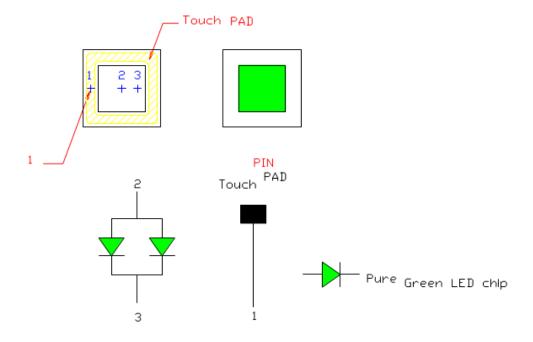
Deremeter	Symbol	Toot Condition	Value			Llmit
Parameter		Test Condition	Min	Тур	Max	Unit
Luminous Intensity	lv	I <sub>F</sub> = 20mA	-	75	-	mcd
Forward Voltage	VF	I <sub>F</sub> = 20mA	ı	3.2	4.0	V
Reverse Leakage Current	lR	V <sub>R</sub> = 5V	-	-	10	μΑ
Dominant Wavelength	λD	I⊧ = 20mA	-	525	-	nm
Spectral Radiation Bandwidth	Δλ	I⊧ = 20mA	-	30	-	nm



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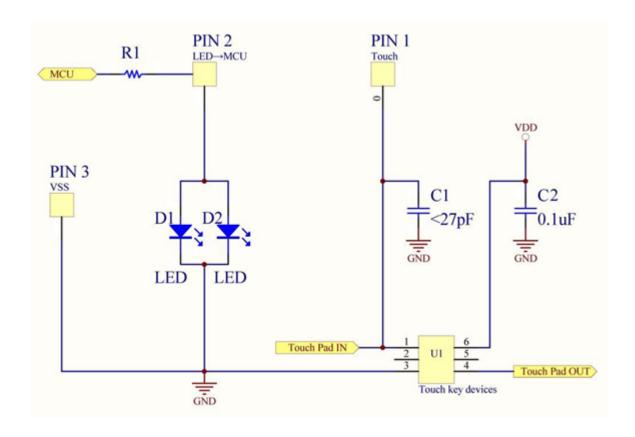


# **INTERNAL CIRCUIT DIAGRAMS**





## **TYPICAL APPLICATION CIRCUITS**



# Internal Components are not customer accessible





### **OPTICAL CHARACTERISTIC CURVES**

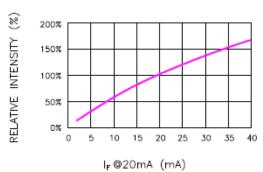


Fig.1 RELATIVE INTENSITY VS. FORWARD CURRENT

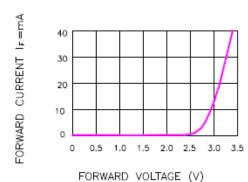
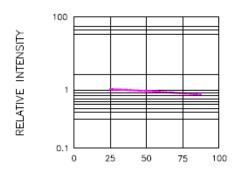
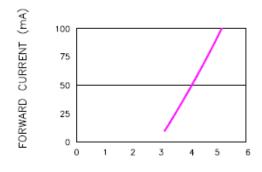


Fig.2 FORWARD CURRENT VS. FORWARD VOLTAGE



LEAD TEMPERATURE(\*C)
Fig.3 RELATIVE INTENSITY VS.LEAD TEMPERATURE
(PULSED 20 mA; 300us
PULSE,10ms PERIOD)



FORWARD VOLTAGE(V)

Fig.4 PEAK FORWARD VOLTAGE

VS.FORWARD(100us TEST PULSE,

1% DUTY CYCLE)

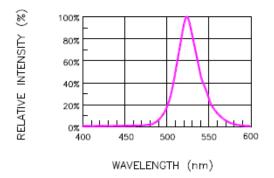
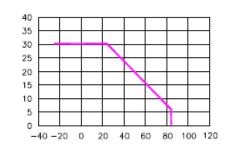


Fig.5 RELATIVE INTENSITY VS. WAVELENGTH



AMBIENT TEMPERATURE (TA)-\*C

Fig.6 MAX. ALLOWABLE DC CURRENT VS. AMBIENT TEMPERATURE

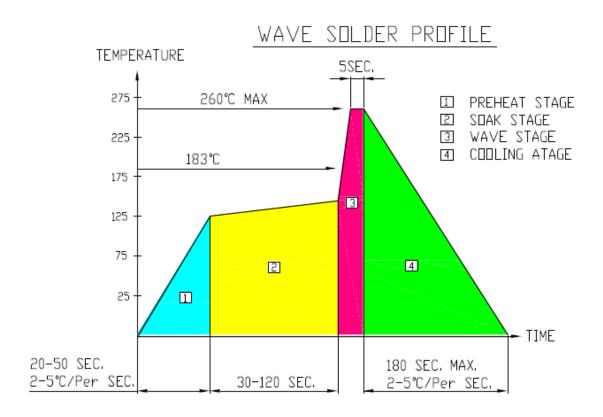


DC CURRENT-mA

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### **SOLDERING CHARACTERISTICS**



#### NOTES

- Recommend pre-heat temperature of 105°C or less (as measured with a thermocouple attached to the LED pins) prior to immersion in the solder wave with a maximum solder bath temperature of 260°C
- 2. Peak wave soldering temperature between 245°C ~ 225°C for 3 sec (5 sec max)
- 3. No more than one wave soldering pass

#### **SOLDERING IRON**

 Basic spec is ≤4 sec when 260°C. If temperature is higher, time should be shorter (+10°C→1 sec). Power dissipation of Iron should be smaller than 15W, and temperature should be controllable. Surface temperature of the device should be under 230°C

#### **REWORK**

- 1. Customer must finish rework within 3 sec under 350°C
- 2. The head of soldering iron cannot touch copper foil

